Electronic supplementary information (ESI) for

Van der Waals Epitaxy of Large-Area Continuous ReS₂ Films on Mica Substrate

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Fig. S1 (a) Digital photograph of monolayer ReS₂ films grown on mica and SiO₂. (b) Optical image of ReS₂ films transferred onto SiO₂ substrate.



Fig. S2 (a) Optical image of multilayer ReS₂ film transferred on SiO₂ substrate. (b) AFM tomography image and height profile of multilayer ReS₂.



Fig. S3 (a) Optical image of the thick ReS₂ film with numerous cover-like embossment.(b) Schematic formation mechanism for cover-like embossment.



Fig. S4 XRD patterns of multilayer ReS₂ films.



Fig. S5 Optical image of flower-like ReS₂ growth on SiO₂ substrate.



Fig. S6 XPS spectra of Re 4f region in: (a) Re₂O₇; (b) intermediate species; (c) Re powder.



Fig. S7 (a) AFM image of the products with only Re₂O₇ as precursor. (b) AFM image of products with excess Re₂O₇ as precursors. The mass of Re₂O₇ and Re are 20 and 50mg, respectively.



Fig. S8 Electrical properties of single-crystal ReS₂ films. (a) Transfer curve of the device. Inset shows the optical image. (b) output curve of the device.



Fig. S9 (a) *I–V* curves in the dark and in the presence of 490 nm incident light with different intensities. (b) Time-dependent photoresponse of device under 490 nm incident light with intensity 0.56 mW/cm² at 1 V. (c-d) the measured photocurrent and calculated responsitivity as a function of incident power.